



# BAT54H

Schottky barrier single diode in small SOD123F package

25 July 2012

Product data sheet

## 1. Product profile

### 1.1 General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a SOD123F small and flat lead Surface-Mounted Device (SMD) plastic package.

### 1.2 Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

### 1.3 Applications

- Ultra high-speed switching
- Voltage clamping
- Line termination
- Inverse-polarity protection

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_F$	forward current		-	-	200	mA
$V_R$	reverse voltage		-	-	30	V
$V_F$	forward voltage	$I_F = 10 \text{ mA}$ ; pulsed; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{\text{amb}} = 25 \text{ } ^\circ\text{C}$	-	-	400	mV

## 2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	 SOD123F	 K  A aaa-003679
2	A	anode		

[1] The marking bar indicates the cathode.

### 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAT54H	SOD123F	plastic surface-mounted package; 2 leads	SOD123F

### 4. Marking

Table 4. Marking codes

Type number	Marking code
BAT54H	AG

### 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage		-	30	V
$I_F$	forward current		-	200	mA
$I_{FRM}$	repetitive peak forward current	$t_p \leq 1$ s; $\delta \leq 0.5$	-	300	mA
$I_{FSM}$	non-repetitive peak forward current	$t_p \leq 10$ ms; $T_{j(\text{init})} = 25$ °C	-	600	mA
$P_{\text{tot}}$	total power dissipation	$T_{\text{amb}} = 25$ °C	[1]	375	mW
$T_j$	junction temperature		-	125	°C
$T_{\text{amb}}$	ambient temperature		-65	125	°C
$T_{\text{stg}}$	storage temperature		-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

### 6. Thermal characteristics

Table 6. Thermal characteristics

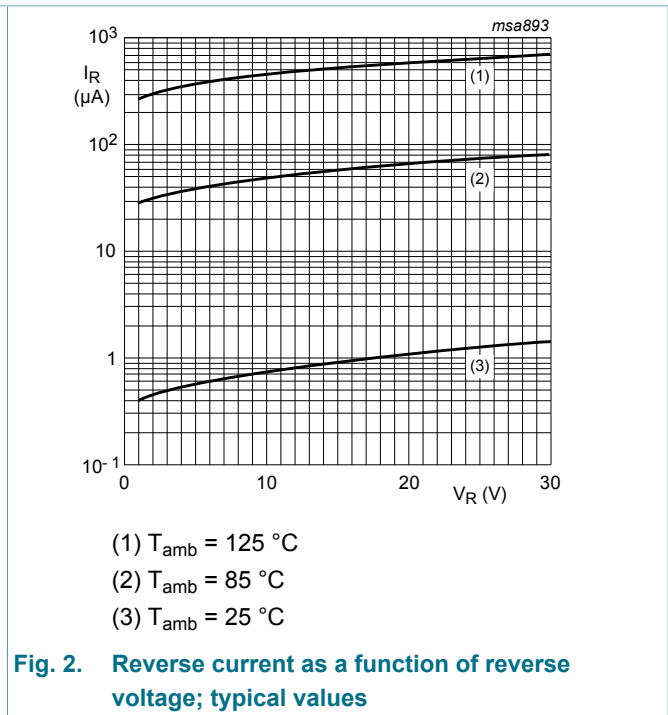
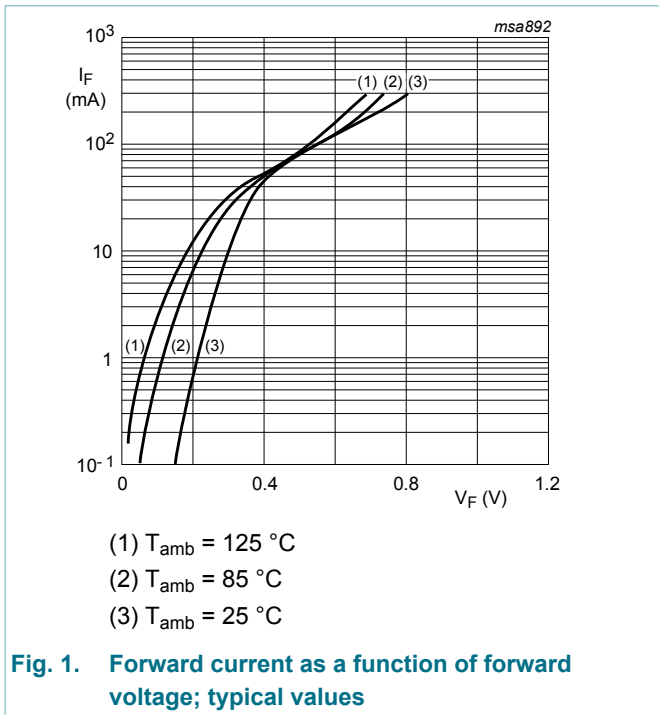
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{\text{th}(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	330	K/W
$R_{\text{th}(j-sp)}$	thermal resistance from junction to solder point		[2]	-	70	K/W

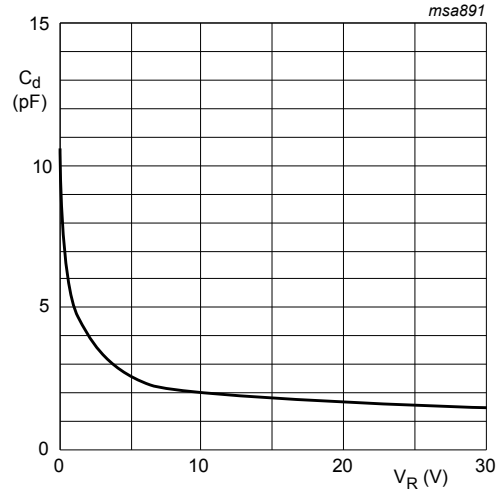
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Soldering point of cathode tab.

## 7. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_F$	forward voltage	$I_F = 0.1 \text{ mA}$ ; pulsed; $t_p \leq 300 \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	240	mV
		$I_F = 1 \text{ mA}$ ; pulsed; $t_p \leq 300 \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	320	mV
		$I_F = 10 \text{ mA}$ ; pulsed; $t_p \leq 300 \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	400	mV
		$I_F = 30 \text{ mA}$ ; pulsed; $t_p \leq 300 \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	500	mV
		$I_F = 100 \text{ mA}$ ; pulsed; $t_p \leq 300 \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	800	mV
$I_R$	reverse current	$V_R = 25 \text{ V}$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	2	$\mu\text{A}$
$C_d$	diode capacitance	$f = 1 \text{ MHz}$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ ; $V_R = 1 \text{ V}$	-	-	10	pF





f = 1 MHz; T<sub>amb</sub> = 25 °C

Fig. 3. Diode capacitance as a function of reverse voltage; typical values

## 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 9. Package outline

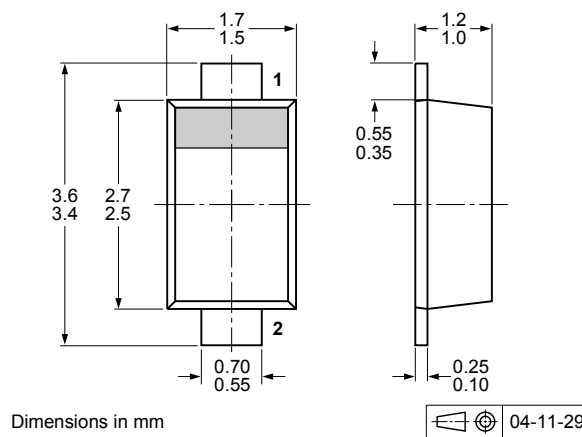


Fig. 4. SOD123F

## 10. Soldering

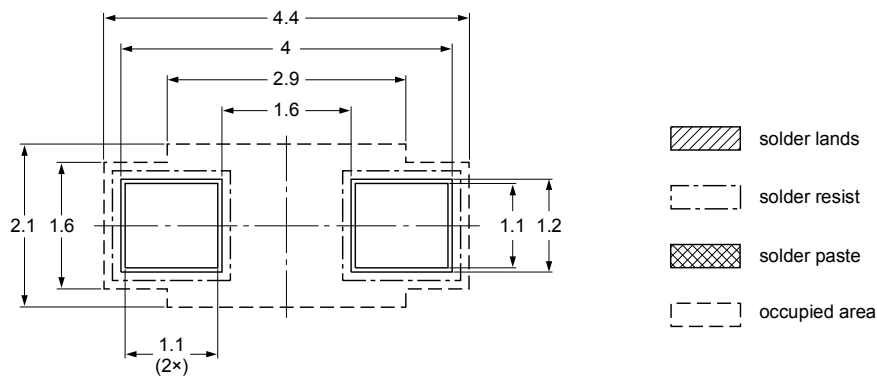


Fig. 5. Reflow soldering footprint for SOD123F (SOD123F)

## 11. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAT54H v.3	20120725	Product data sheet	-	BAT54H v.2
Modifications:	<ul style="list-style-type: none"> <li>The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Section "Test information" added</li> </ul>			
BAT54H v.2	20100128	Product data sheet	-	BAT54H v.1
BAT54H v.1	20050407	Product data sheet	-	

## 12. Legal information

### 12.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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